

N-Channel Enhancement Mode MOSFET **TDM3536**

DESCRIPTION

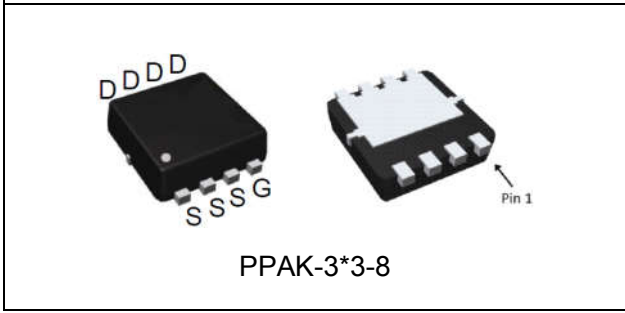
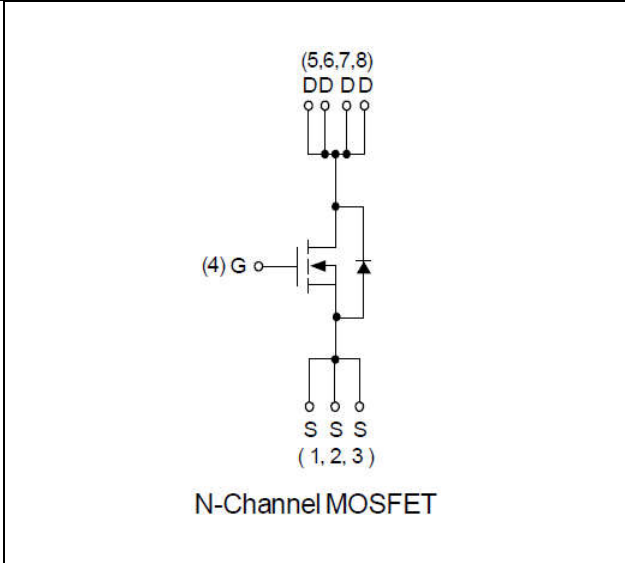
The TDM3536 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

GENERAL FEATURES

- RDS(ON) < 5.3mΩ @ VGS=4.5V
RDS(ON) < 3.6mΩ @ VGS=10V
- High Power and current handling capability
- Surface Mount Package
- Lead Free and Green Devices available(RoHS Compliant)

Application

- PWM applications
- Load switch
- Power management
- Powered Systems



ABSOLUTE MAXIMUM RATINGS(TA=25 °C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current @ Continuous	I _D (T _C =25 °C)	70	A
	I _D (T _C =100 °C)	46	A
Drain Current @ Current-Pulsed (Note 1)	I _{DM} (T _C =25 °C)	140	A
Maximum Power Dissipation	P _D (T _C =25 °C)	31.3	W
	P _D (T _C =100 °C)	12.5	
Drain Current @ Continuous	I _D (T _A =25 °C)	18	A
	I _D (T _A =70 °C)	14	A
Maximum Power Dissipation	P _D (T _A =25 °C)	2.08	W
	P _D (T _A =70 °C)	1.3	
Thermal Resistance,Junction-to-Ambient (Note 2)	R _{θJA} (t<10s)	40	°C/W
	R _{θJA} (Steady State)	60	
Thermal Resistance,Junction-to-Case	R _{θJC} (Steady State)	4	°C/W
Maximum Operating Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55 To 150	°C

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ELECTRICAL CHARACTERISTICS ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=24V, V_{GS}=0V$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.5	1.8	2.5	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=9A$	-	4.1	5.3	m Ω
		$V_{GS}=10V, I_D=12A$	-	3.0	3.6	
		$T_J=125^{\circ}\text{C}$	-	4.35	-	
DYNAMIC CHARACTERISTICS (Note3)						
Gate Resistance	R_G	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	-	1	2	Ω
Input Capacitance	C_{iss}	$V_{DS}=15V, V_{GS}=0V, F=1.0\text{MHz}$	-	1350	-	PF
Output Capacitance	C_{oss}		-	900	-	PF
Reverse Transfer Capacitance	C_{rss}		-	65	-	PF
SWITCHING CHARACTERISTICS (Note 3)						
Turn-on Delay Time	$t_{d(on)}$	$V_{DS}=15V, R_L=15\Omega, V_{GEN}=10V, R_G=6\Omega, I_D=1A$	-	13	-	nS
Turn-on Rise Time	t_r		-	7.6	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	26	-	nS
Turn-Off Fall Time	t_f		-	35	-	nS
Total Gate Charge	Q_g	$V_{DS}=15V, I_D=15A, V_{GS}=15V$	-	8.8	-	nC
Gate-Source Charge	Q_{gs}		-	4.8	-	nC
Gate-Drain Charge	Q_{gd}		-	2	-	nC
Body Diode Reverse Recovery Time	T_{rr}	$I_F=5A, dI/dt=100A/\mu s$	-	16	-	nS
Body Diode Reverse Recovery Charge	Q_{rr}		-	22	-	nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode Forward Voltage (Note 2)	V_{SD}	$V_{GS}=0V, I_S=2A$	-	0.77	1.1	V

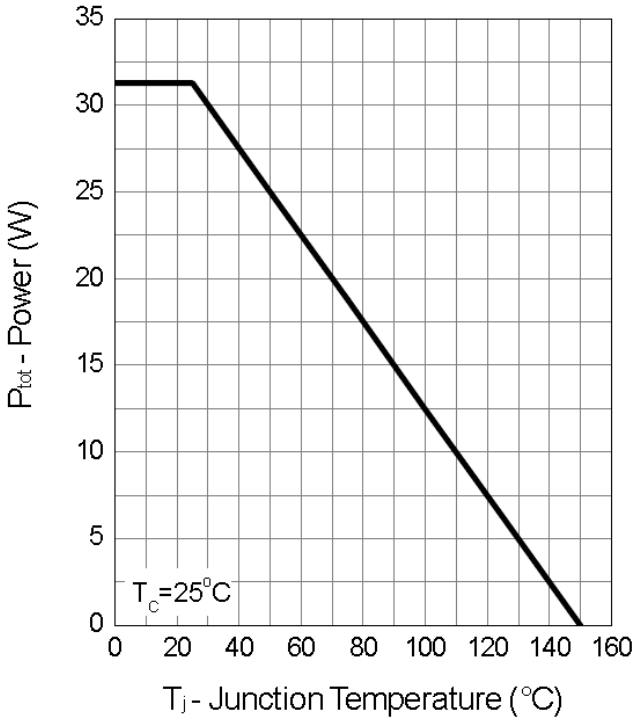
NOTES:

1. Pulse width limited by max. junction temperature.
2. $R_{\theta JA}$ steady state=999s. $R_{\theta JA}$ is measured with the device mounted on 1in2, Fr-4 board with 2oz.Copper
3. Guaranteed by design, not subject to production testing

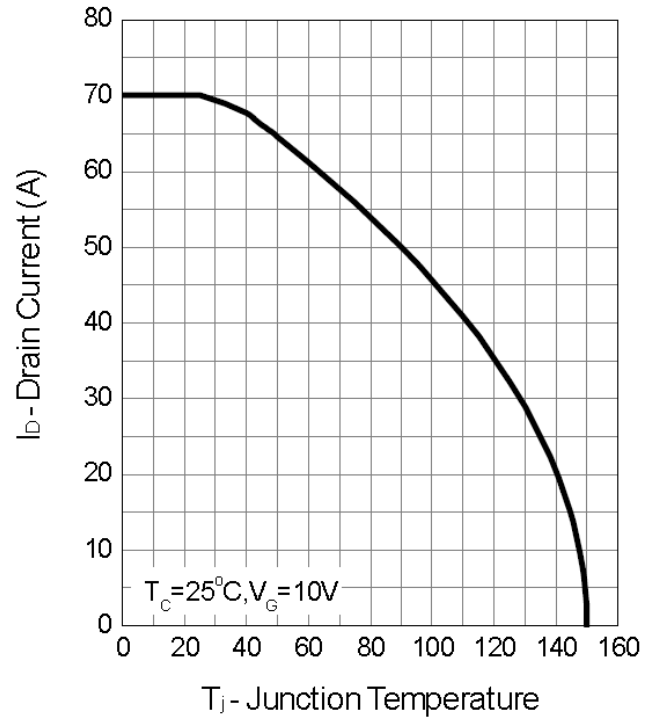
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Typical Operating Characteristics

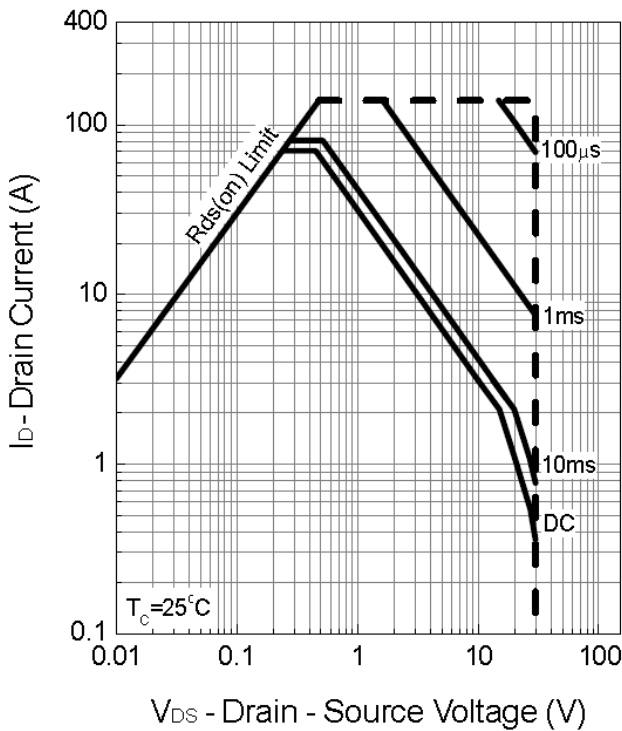
Power Dissipation



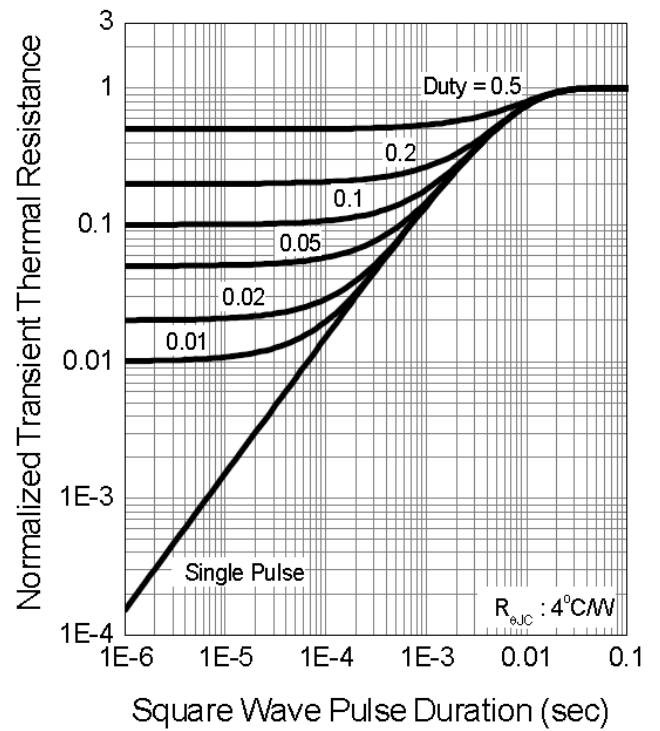
Drain Current



Safe Operation Area



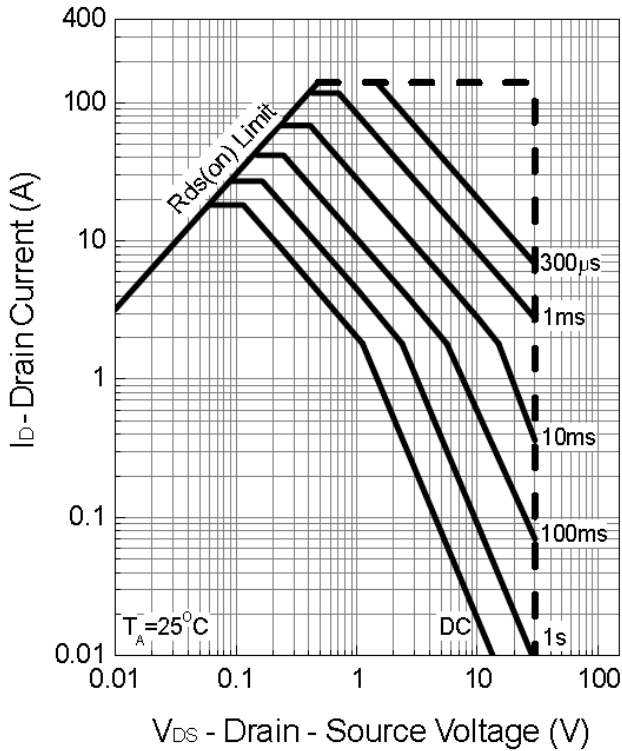
Thermal Transient Impedance



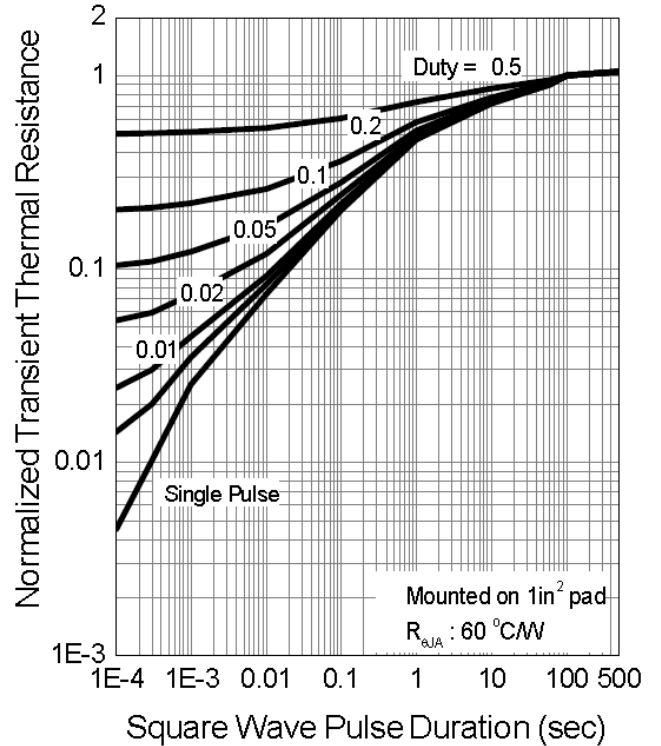
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Typical Operating Characteristics(Cont.)

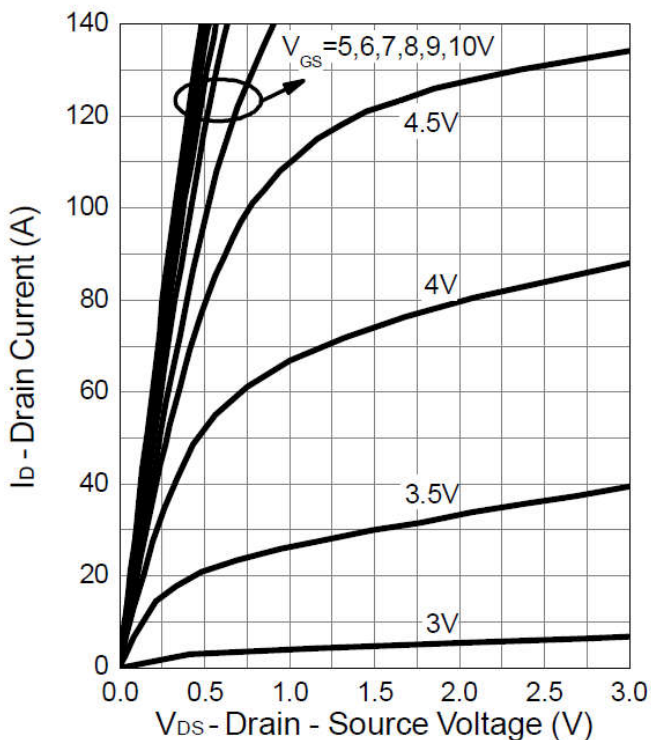
Safe Operation Area



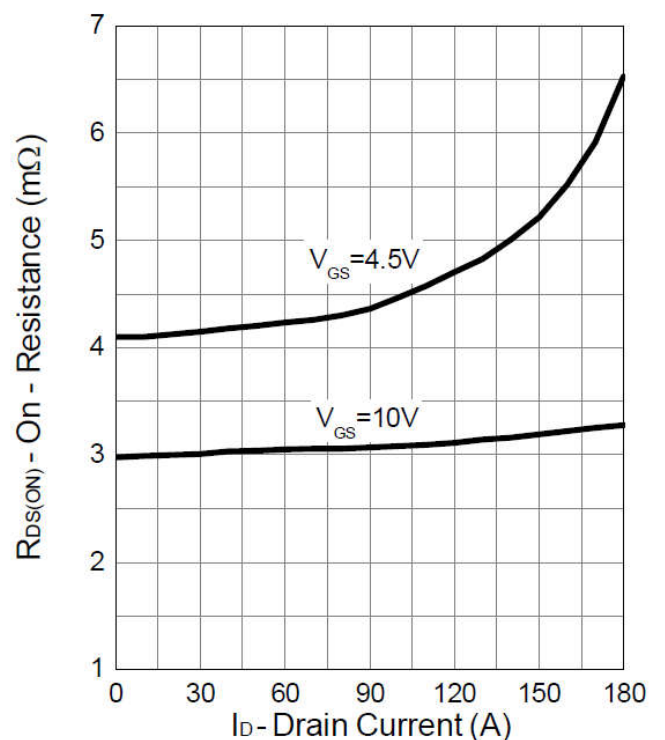
Thermal Transient Impedance



Output Characteristics



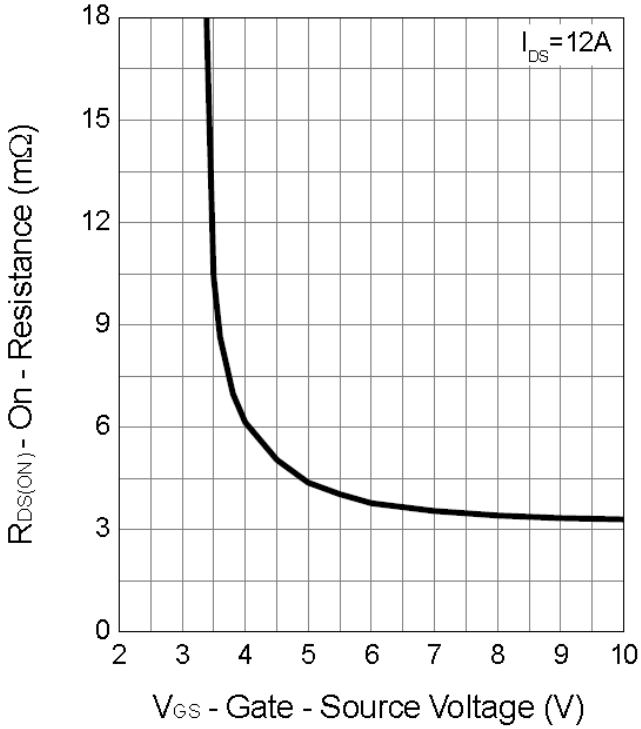
Drain-Source On Resistance



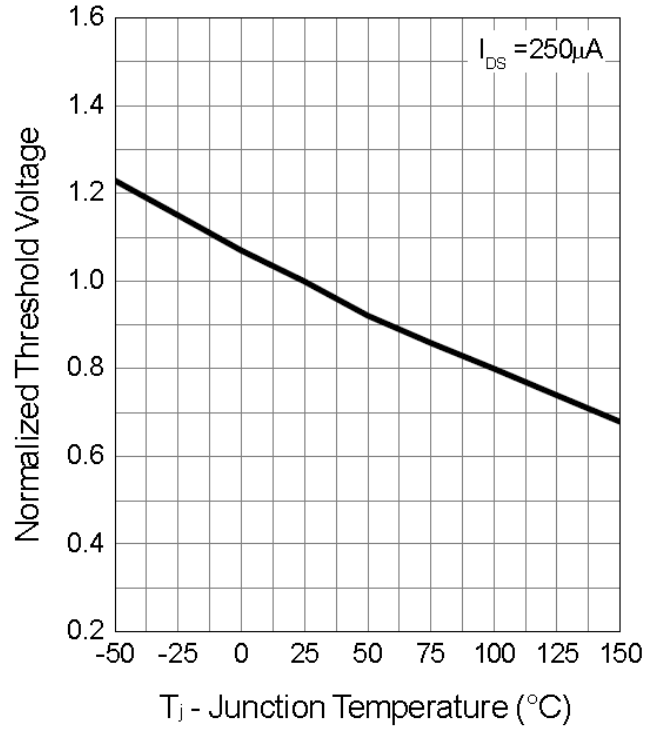
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Typical Operating Characteristics (Cont.)

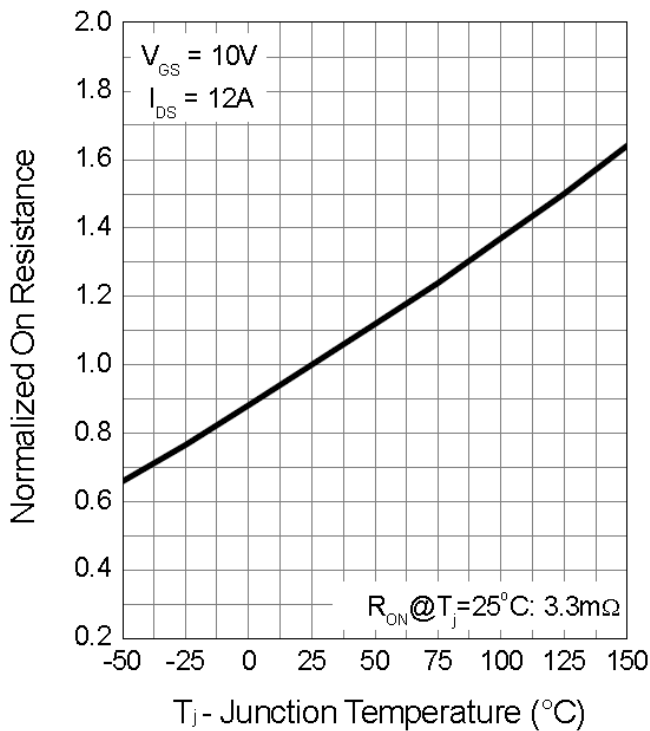
Gate-Source On Resistance



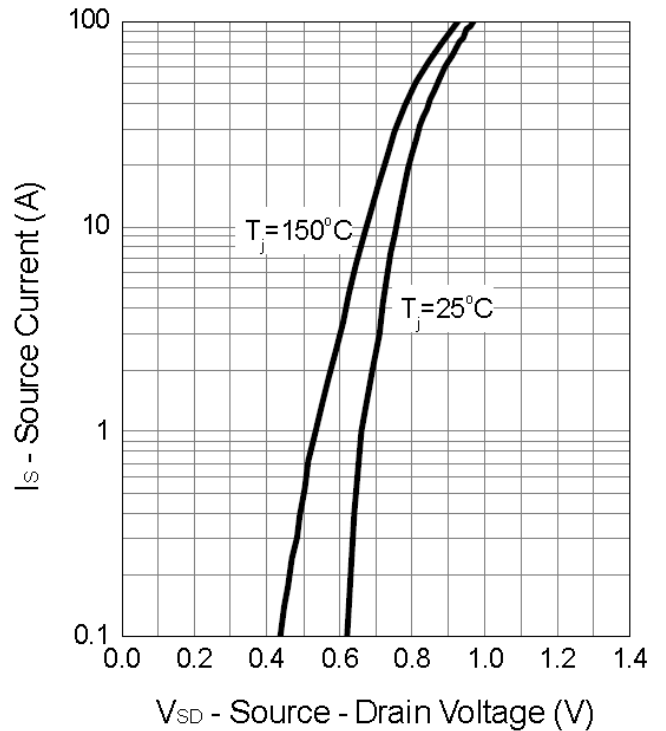
Gate Threshold Voltage



Drain-Source On Resistance



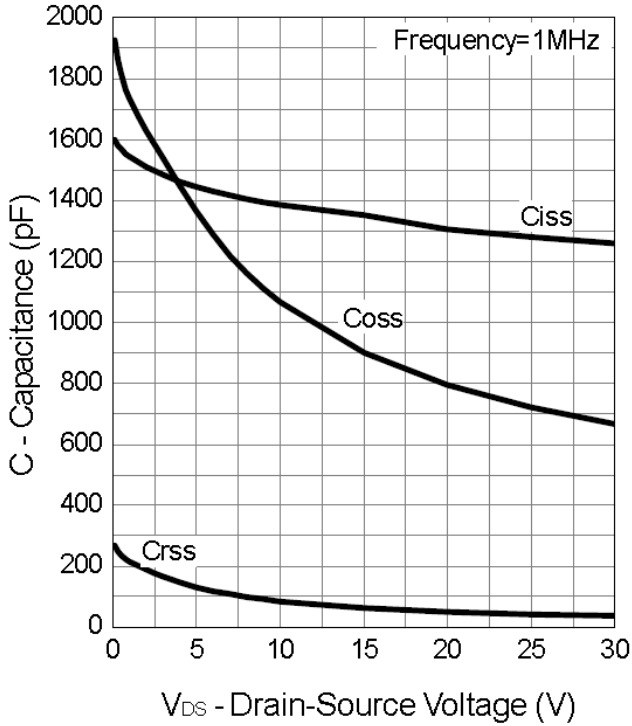
Source-Drain Diode Forward



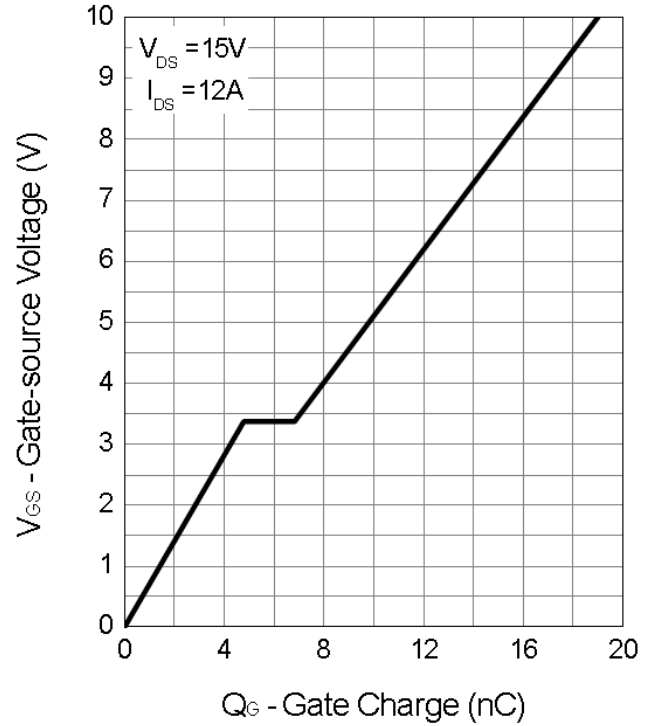
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Typical Operating Characteristics (Cont.)

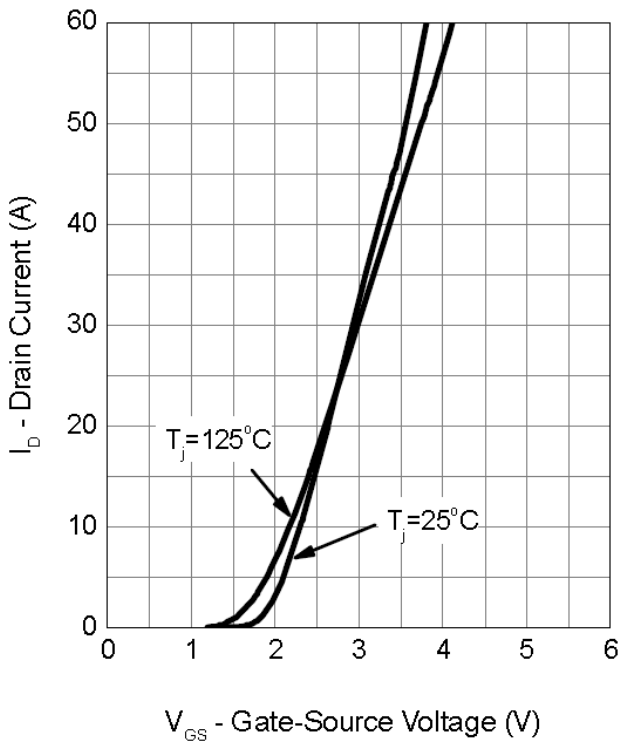
Capacitance



Gate Charge



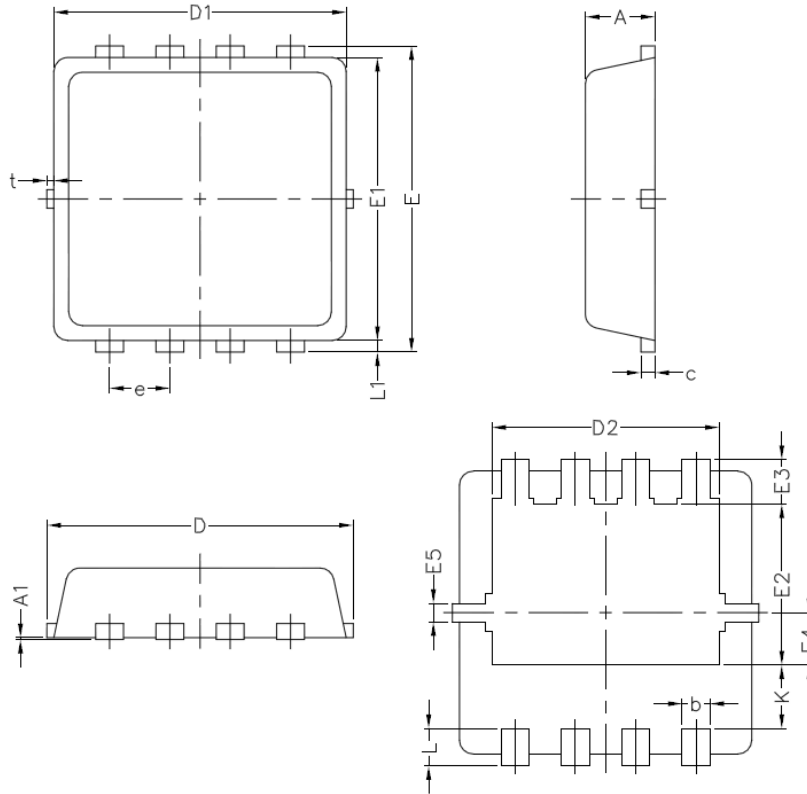
Transfer Characteristics



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Package Information

PPAK-3*3-8 Package



Symbol	PPAK-3*3-8(mm)		
	Min	Nom	Max
A	0.70	0.75	0.85
A1	/	/	0.05
b	0.20	0.30	0.40
c	0.10	0.152	0.25
D	3.15	3.3	3.45
D1	3.00	3.15	3.30
D2	2.25	2.45	2.65
E	3.15	3.30	3.45
E1	2.90	3.05	3.20
E2	1.54	1.74	1.94
E3	0.28	0.48	0.68
E4	0.37	0.57	0.77
E5	0.10	0.20	0.30
e	0.60	0.65	0.70
K	0.49	0.69	0.89
L	0.30	0.40	0.50
L1	0.06	0.125	0.20
t	/	/	0.13

Design Notes